| ASSOCIATION CONNECTING<br>ELECTRONICS INDUSTRIES® INFORMATION CONNECTING<br>international and Pan-A | Bannockt   | ourn, Illinois. A   | ll rights reserved untions. | under both               | This docume<br>level parts, t | ent is a decla<br>he declaratio                                 | ration of the<br>n encompas | substances<br>ses all lowe | within the n<br>er level mate | nanufacturen<br>rials for whi   | r listed iten<br>ch the man     | n. Note: if<br>ufacturer      | the item is an as has engineering | sembly with lower responsibility. |  |
|---|--|---------------------|-----------------------------|--------------------------|-------------------------------|---|-----------------------------|----------------------------|-------------------------------|---------------------------------|---------------------------------|-------------------------------|-----------------------------------|-----------------------------------|--|
|   | IPC Web Site for Information on IPC-1752 Standard Form Typ<br>http://www.ipc.org/IPC-175x Distribute |                     |                             |                          | e *                           | Declaration Class *<br>Class 6 - RoHS Yes/No, Homogeneous Mater |                             |                            |                               |                                 | als and Mfg Information         |                               |                                   |                                   |  |
| Supplier Information  |  |                     |                             |                          |                               |   |                             |                            |                               |                                 |                                 |                               |                                   |                                   |  |
| Company name*   | Company uni  | Company unique ID   |                             |                          | Unique ID Authority           |   |                             |                            |                               | Response Date*                  |                                 |                               |                                   |                                   |  |
| onsemi  |  |                     |                             |                          |                               |   |                             |                            | 2025-07-04                    |                                 |                                 |                               |                                   |                                   |  |
| Contact Name Title  |  |                     | Title - Contact             |                          |                               | Phone - Contact*  |                             |                            |                               |                                 | Email - Contact*                |                               |                                   |                                   |  |
| Product-Env-Stewards Pro  |  |                     | Product Enviro Compliance   |                          |                               | NA  |                             |                            |                               |                                 | Product-Env-Stewards@onsemi.com |                               |                                   |                                   |  |
| Authorized Representative* Ti   |  |                     | Title - Representative      |                          |                               | Phone - Representative*   |                             |                            |                               | 1                               | Email - Representative*         |                               |                                   |                                   |  |
| Product-Env-Stewards  | Product Enviro Compliance  |                     |                             |                          | NA                            |   |                             |                            |                               | Product-Env-Stewards@onsemi.com |                                 |                               |                                   |                                   |  |
| Requester Item Number   | Mfr Item   | n Number            | Mfr Item Name               |                          |                               | Effective Date Version Manufacturing Site                       |                             | ng Site                    | We                            | ight*                           | UOM                             | Unit Type                     |                                   |                                   |  |
|   | SLV74L<br>G  |                     |                             | OG CMOS D FLIP FLOP 8BIT |                               | 2025-07-04  |                             | :                          | PH1                           |                                 | 69.                             | 08                            | mg                                | Each                              |  |
| Manufacturing Proccess Informatio   | n  |                     |                             |                          |                               |   | ·                           | ·                          |                               |                                 | ·                               |                               |                                   |                                   |  |
| Terminal Plating / Grid Array Mater   | ial 7  | Terminal Base Alloy |                             | J-STD-020 MS             | L Rating                      | Peak Process Body Temperat                                      |                             | Temperatu                  | ure Max Time at Peak Tempe    |                                 | emperature                      | ature Number of Reflow Cycles |                                   | les                               |  |
| Precious metal (e.g. Ag,Au, NiPdAu) (no<br>Sn)  |  | CU Alloy 1          |                             | 1                        |                               | 260   |                             | C                          | <b>30</b> sec                 |                                 | seconds                         | econds 3                      |                                   |                                   |  |
| Comments  |  |                     |                             |                          |                               |   |                             |                            |                               |                                 |                                 |                               |                                   |                                   |  |
| evel 1 - maximum time at peak temperature   | during so  | ldering is 10-3     | 0 seconds                   |                          |                               |   |                             |                            |                               |                                 |                                 |                               |                                   |                                   |  |
| For more information regarding material co  | nposition  | please refer to     | page 3                      |                          |                               |   |                             |                            |                               |                                 |                                 |                               |                                   |                                   |  |

| RoHS Material Composition Declaration  |  |  |   | Declaration Type *                              | Detailed  |  |  |  |  |  |  |  |
|--|--|--|---|---|---|--|--|--|--|--|--|--|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  | RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP). |  |   |   |   |  |  |  |  |  |  |  |
| cadmium, hexavalentchromium, polybrominate<br>contains a RoHS restricted substance inexcess<br>encompass all such components. Supplier certif<br>as of the date that Supplier completes this form<br>Company acknowledges that Supplier may hav<br>independently verified information provided by<br>certification in this paragraph. If the Company a | ed biphenyls and/or polybrominated dip<br>of an applicable quantity limit, please ir<br>ies that it gathered the information it pro-<br>.Supplier acknowledges that Company<br>e relied on informationprovided by othe<br>v others, Supplier agrees that, at a minin<br>and the Supplier enter into a written agre<br>pource of the Supplier's liability and the   | henyl ethers (each a "<br>ndicate below which, i<br>ovides in this form us<br>will rely on this certifiers<br>in completing this<br>num, itssuppliers have<br>eement with respect to<br>Company's remedies | RoHS restricted substance") in exce<br>if any, RoHS exemption you believe<br>ing appropriate methods to ensure if<br>ication in determining the complian<br>form, and that Supplier may not have<br>e provided certifications regarding the<br>to the identified part, the terms and cc<br>for issues that arise regarding inform | ce of its products with European Union membe    | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>l correct to the best of its knowledge and belief,<br>r state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>tions are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |  |  |  |  |  |  |  |
| RoHS Declaration * 1 - Item(s)   | does not contain RoHS restricted substa  | on above   | Supplier Acceptance   | * Accepted                                      |   |  |  |  |  |  |  |  |
| Exemption: If the declared item does not con applicable exemptions.  | ntain RoHS restricted substances per   | the definition above   | except for defined RoHS exempti   | ons, then select the corresponding response i   | n the RoHS Declaration above and choose all   |  |  |  |  |  |  |  |
| Exemption List Version   | EL-2011/534/EU   |  |   |   |   |  |  |  |  |  |  |  |
| Declaration Signature  |  |  |   |   |   |  |  |  |  |  |  |  |
| Instructions: Complete all of the required fin<br>Requester) and click on Submit Form to have  | elds on all pages of this form. Select the form returned to the Requester  | he "Accepted" on th  | e Supplier Acceptance drop-down   | . This will display the signature area. Digital | lly sign the declaration (if required by the  |  |  |  |  |  |  |  |
| Supplier Digital Signature Ra  | stislav Drska  | Le   |   |   |   |  |  |  |  |  |  |  |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance               | CAS              | Exempt | Weight  | Unit of Measure |
|----------------------|--------|-----------------|----------|-------------------------|------------------|--------|---------|-----------------|
| Die                  | 0.09   | mg              | Supplier | Silicon (Si)            | 7440-21-3        |        | 0.09    | mg              |
| Die Attach           | 2.46   | mg              |          | Epoxy resin             | proprietary data |        | 0.246   | mg              |
|                      |        |                 | Supplier | Silver (Ag)             | 7440-22-4        |        | 1.968   | mg              |
|                      |        |                 | Supplier | Formaldehyde Polymer    | 9003-36-5        |        | 0.246   | mg              |
| Lead Frame           | 38.58  | mg              | Supplier | Zinc (Zn)               | 7440-66-6        |        | 0.0463  | mg              |
|                      |        |                 | Supplier | Iron (Fe)               | 7439-89-6        |        | 0.9066  | mg              |
|                      |        |                 | Supplier | Copper (Cu)             | 7440-50-8        |        | 37.6155 | mg              |
|                      |        |                 | Supplier | Phosphorus (P)          | 7723-14-0        |        | 0.0116  | mg              |
| Mold Compound-Black  | 24.35  | mg              |          | Epoxy resin             | proprietary data |        | 1.8263  | mg              |
|                      |        |                 | Supplier | Phenolic Resin          | Proprietary Data |        | 0.6088  | mg              |
|                      |        |                 | Supplier | Silica Amorphous (SiO2) | 7631-86-9        |        | 1.8263  | mg              |
|                      |        |                 | Supplier | Carbon Black (C)        | 1333-86-4        |        | 0.1217  | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2)     | 60676-86-0       |        | 19.967  | mg              |
| Plating              | 3.44   | mg              | Supplier | Palladium (Pd)          | 7440-05-3        |        | 0.2614  | mg              |
|                      |        |                 | В        | Nickel (Ni)             | 7440-02-0        |        | 3.1304  | mg              |
|                      |        |                 | Supplier | Gold (Au)               | 7440-57-5        |        | 0.0482  | mg              |
| Wire Bond - Au       | 0.16   | mg              | Supplier | Gold (Au)               | 7440-57-5        |        | 0.16    | mg              |

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).